Vishay Siliconix



| THERMAL RESISTANCE RATINGS | | | | |
|-------------------------------------|-------------------|------|------|------|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT |
| Maximum Junction-to-Ambient | R _{thJA} | - | 40 | |
| Case-to-Sink, Flat, Greased Surface | R _{thCS} | 0.24 | - | °C/W |
| Maximum Junction-to-Case (Drain) | R _{thJC} | - | 0.26 | |

| PARAMETER | SYMBOL | TES | ST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|-----------------------|--|--|------------|-----------|-------------|-----------|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} | = 0 V, I _D = 250 μA | 500 | - | - | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_J$ | Reference | ce to 25 °C, I _D = 1 mA | - | 0.54 | - | V/°C |
| Gate-Source Threshold Voltage | V _{GS(th)} | V _{DS} = | = V _{GS} , I _D = 250 μΑ | 3.0 | - | 5.0 | V |
| Gate-Source Leakage | I _{GSS} | | V _{GS} = ± 30 V | - | - | ± 100 | nA |
| Zara Cata Valtaga Drain Current | | V _{DS} = | $V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | | - | 50 | <u> </u> |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 400 V | /, V _{GS} = 0 V, T _J = 150 °C | - | - | 250 | μA |
| Drain-Source On-State Resistance | R _{DS(on)} | $V_{GS} = 10 V$ | I _D = 32 A ^b | - | 0.135 | 0.16 | Ω |
| Forward Transconductance | g fs | V _{DS} | = 50 V, I _D = 32 A | 14 | - | - | S |
| Dynamic | | | | | • | • | |
| Input Capacitance | C _{iss} | $V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5 | | - | 5280 | - | - |
| Output Capacitance | Coss | | | - | 550 | - | |
| Reverse Transfer Capacitance | C _{rss} | | | - | 45 | - | |
| Output Capacitance | C _{oss} | V _{GS} = 0 V | V _{DS} = 1.0 V, f = 1.0 MHz | - | 5630 | - | - pF - |
| | | | V _{DS} = 400 V, f = 1.0 MHz | - | 155 | - | |
| Effective Output Capacitance | C _{oss} eff. | | V _{DS} = 0 V to 400 V ^c | - | 265 | - | |
| Total Gate Charge | Qg | | | - | - | 190 | |
| Gate-Source Charge | Q_gs | $V_{GS} = 10 V$ | $I_D = 32 \text{ A}, V_{DS} = 400 \text{ V}^{b}$ | - | - | 59 | nC |
| Gate-Drain Charge | Q _{gd} | | | - | - | 84 | |
| Turn-On Delay Time | t _{d(on)} | | · | - | 28 | - | - ns |
| Rise Time | t _r | V _{DD} = | = 250 V, I _D = 32 A, | - | 120 | - | |
| Turn-Off Delay Time | t _{d(off)} | Rg = | 4.3 Ω, $V_{GS} = 10 V^{b}$ | - | 48 | - | |
| Fall Time | t _f | | | - | 54 | - | |
| Drain-Source Body Diode Characteristic | s | | | | | | |
| Continuous Source-Drain Diode Current | I _S | MOSFET sym showing the | | - | - | 32 | _ |
| Pulsed Diode Forward Current ^a | I _{SM} | integral reverse p - n junction diode | | - | - | 130 | A |
| Body Diode Voltage | V _{SD} | T _J = 25 °C | C, I _S = 32 A, V _{GS} = 0 V ^b | - | - | 1.5 | V |
| Body Diode Reverse Recovery Time | t _{rr} | | | - | 530 | 800 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | T _J = 25 °C, I _F | = 32 A, dl/dt = 100 A/µs ^b | - | 9.0 | 13.5 | μC |
| Body Diode Reverse Recovery Current | I _{RRM} | 1 | | - | 30 | - | Α |
| Forward Turn-On Time | t _{on} | Intrinsic tu | Irn-on time is negligible (turn | -on is dor | ninated b | $v L_s$ and | L) |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. Pulse width \leq 400 µs; duty cycle \leq 2 %.

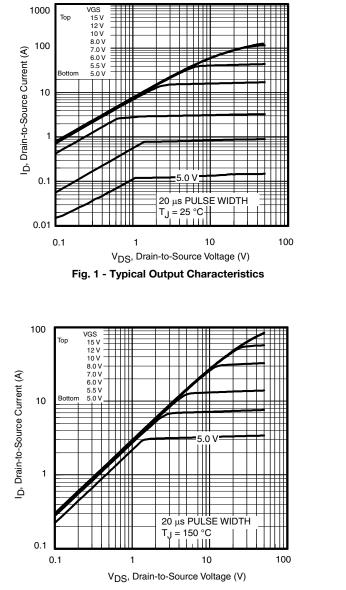
c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 2 - Typical Output Characteristics

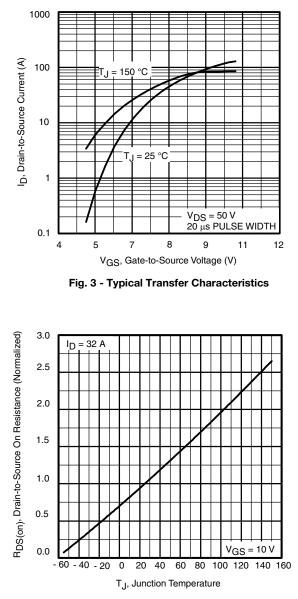


Fig. 4 - Normalized On-Resistance vs. Temperature

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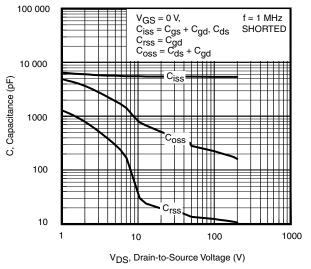


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

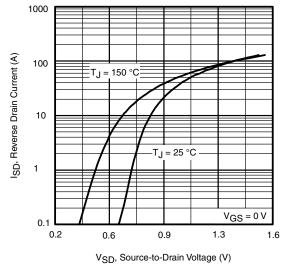


Fig. 7 - Typical Source-Drain Diode Forward Voltage

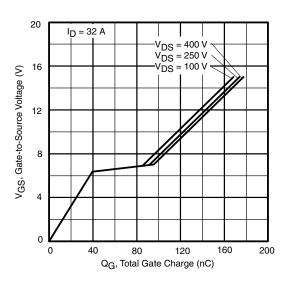


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

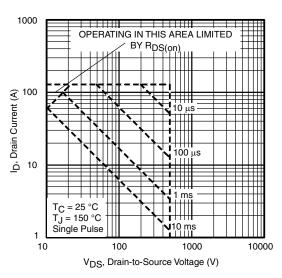


Fig. 8 - Maximum Safe Operating Area

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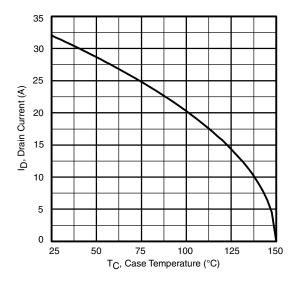


Fig. 9 - Maximum Drain Current vs. Case Temperature

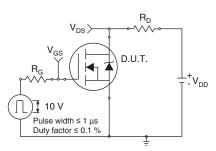


Fig. 10a - Switching Time Test Circuit

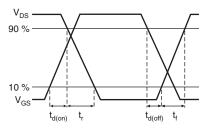


Fig. 10b - Switching Time Waveforms

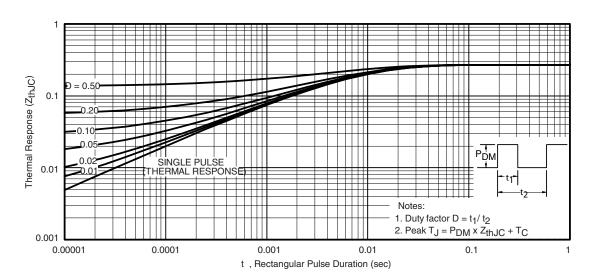


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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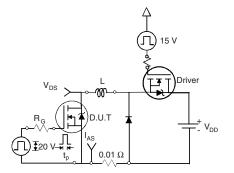


Fig. 12a - Unclamped Inductive Test Circuit

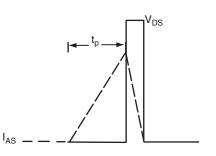


Fig. 12b - Unclamped Inductive Waveforms

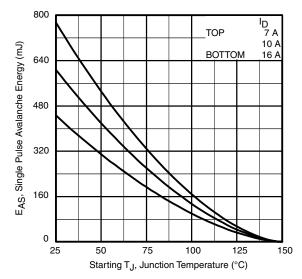


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

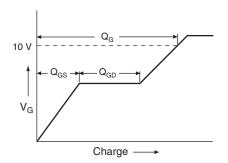


Fig. 13a - Basic Gate Charge Waveform

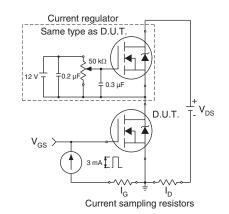


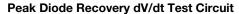
Fig. 13b - Gate Charge Test Circuit

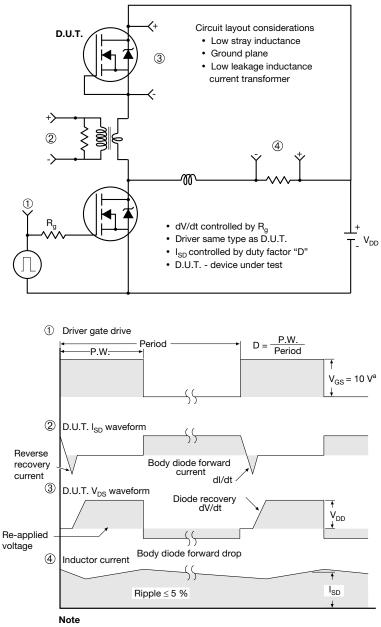
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a. V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel

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TO-247AC (High Voltage)

VERSION 1: FACILITY CODE = 9





Section C--C, D--D, E--E

| 1 | \ |
|---|-------|
| | |
| | |
| | |

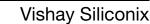
| | MILLIN | IETERS | |
|------|--------|--------|-------|
| DIM. | MIN. | MAX. | NOTES |
| А | 4.83 | 5.21 | |
| A1 | 2.29 | 2.55 | |
| A2 | 1.50 | 2.49 | |
| b | 1.12 | 1.33 | |
| b1 | 1.12 | 1.28 | |
| b2 | 1.91 | 2.39 | 6 |
| b3 | 1.91 | 2.34 | |
| b4 | 2.87 | 3.22 | 6, 8 |
| b5 | 2.87 | 3.18 | |
| С | 0.55 | 0.69 | 6 |
| c1 | 0.55 | 0.65 | |
| D | 20.40 | 20.70 | 4 |

| | MILLIN | IETERS | |
|------|----------|--------|-------|
| DIM. | MIN. | MAX. | NOTES |
| D1 | 16.25 | 16.85 | 5 |
| D2 | 0.56 | 0.76 | |
| E | 15.50 | 15.87 | 4 |
| E1 | 13.46 | 14.16 | 5 |
| E2 | 4.52 | 5.49 | 3 |
| е | 5.44 BSC | | |
| L | 14.90 | 15.40 | |
| L1 | 3.96 | 4.16 | 6 |
| ØP | 3.56 | 3.65 | 7 |
| Ø P1 | 7.19 |) ref. | |
| Q | 5.31 | 5.69 | |
| S | 5.54 | 5.74 | |

Notes

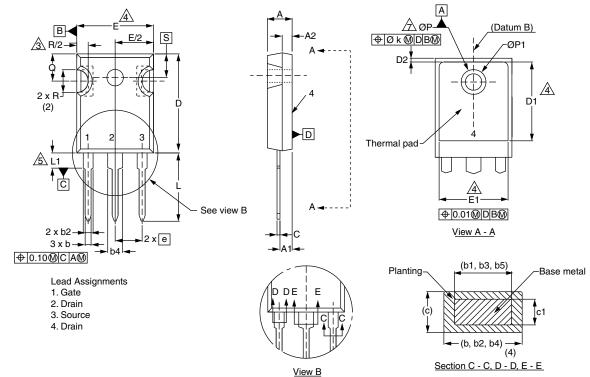
- ⁽¹⁾ Package reference: JEDEC[®] TO247, variation AC
- (2) All dimensions are in mm
- ⁽³⁾ Slot required, notch may be rounded
- ⁽⁴⁾ Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outermost extremes of the plastic body
- ⁽⁵⁾ Thermal pad contour optional with dimensions D1 and E1
- (6) Lead finish uncontrolled in L1
- (7) Ø P to have a maximum draft angle of 1.5° to the top of the part with a maximum hole diameter of 3.91 mm
- (8) Dimension b2 and b4 does not include dambar protrusion. Allowable dambar protrusion shall be 0.1 mm total in excess of b2 and b4 dimension at maximum material condition

Revision: 19-Oct-2020





VERSION 2: FACILITY CODE = Y



| | MILLIN | IETERS | |
|------|--------|--------|-------|
| DIM. | MIN. | MAX. | NOTES |
| A | 4.58 | 5.31 | |
| A1 | 2.21 | 2.59 | |
| A2 | 1.17 | 2.49 | |
| b | 0.99 | 1.40 | |
| b1 | 0.99 | 1.35 | |
| b2 | 1.53 | 2.39 | |
| b3 | 1.65 | 2.37 | |
| b4 | 2.42 | 3.43 | |
| b5 | 2.59 | 3.38 | |
| с | 0.38 | 0.86 | |
| c1 | 0.38 | 0.76 | |
| D | 19.71 | 20.82 | |
| D1 | 13.08 | - | |

| | MILLIN | IETERS | |
|------|--------|--------|-------|
| DIM. | MIN. | MAX. | NOTES |
| D2 | 0.51 | 1.30 | |
| E | 15.29 | 15.87 | |
| E1 | 13.72 | - | |
| е | 5.46 | BSC | |
| Øk | 0.2 | 254 | |
| L | 14.20 | 16.25 | |
| L1 | 3.71 | 4.29 | |
| ØР | 3.51 | 3.66 | |
| Ø P1 | - | 7.39 | |
| Q | 5.31 | 5.69 | |
| R | 4.52 | 5.49 | |
| S | 5.51 | BSC | |
| | | | |

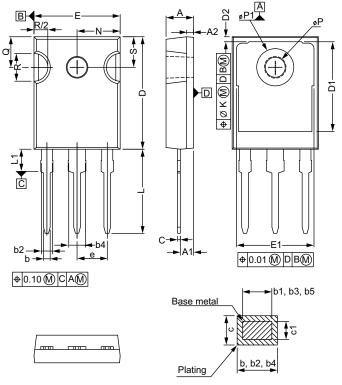
Notes

- ⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5M-1994
- ⁽²⁾ Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- ⁽⁴⁾ Thermal pad contour optional with dimensions D1 and E1
- ⁽⁵⁾ Lead finish uncontrolled in L1
- ⁽⁶⁾ Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- ⁽⁷⁾ Outline conforms to JEDEC outline TO-247 with exception of dimension c



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VERSION 3: FACILITY CODE = N



| | MILLIMETERS | | | MILLIMETERS | |
|------|-------------|-------|------|-------------|-------|
| DIM. | MIN. | MAX. | DIM. | MIN. | MAX. |
| А | 4.65 | 5.31 | D2 | 0.51 | 1.35 |
| A1 | 2.21 | 2.59 | E | 15.29 | 15.87 |
| A2 | 1.17 | 1.37 | E1 | 13.46 | - |
| b | 0.99 | 1.40 | e | 5.46 | BSC |
| b1 | 0.99 | 1.35 | k | 0.2 | 254 |
| b2 | 1.65 | 2.39 | L | 14.20 | 16.10 |
| b3 | 1.65 | 2.34 | L1 | 3.71 | 4.29 |
| b4 | 2.59 | 3.43 | N | 7.62 | BSC |
| b5 | 2.59 | 3.38 | Р | 3.56 | 3.66 |
| С | 0.38 | 0.89 | P1 | - | 7.39 |
| c1 | 0.38 | 0.84 | Q | 5.31 | 5.69 |
| D | 19.71 | 20.70 | R | 4.52 | 5.49 |
| D1 | 13.08 | - | S | 5.51 | BSC |

Notes

⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5M-1994

⁽²⁾ Contour of slot optional

⁽³⁾ Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

⁽⁴⁾ Thermal pad contour optional with dimensions D1 and E1

⁽⁵⁾ Lead finish uncontrolled in L1

⁽⁶⁾ Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")

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